

# **Ambient Light Sensor**



## **DESCRIPTION**

TEMD6200FX01 is a high speed and high sensitive PIN photodiode in a miniature flat plastic package. It is spectral sensitivity is closely matched to the human eye.

#### **FEATURES**

· Package type: Surface mount

• Package form: 0805

• Dimensions (L x W x H in mm): 2 x 1.25 x 0.85

• Radiant sensitive area (in mm2): 0.27

AEC-Q101 qualified

· High photo sensitivity

· Adapted to human eye responsivity

• Angle of half sensitivity:  $\varphi = \pm 60^{\circ}$ 

• Floor life: 168 h, MSL 3, acc. J-STD-020

 Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

### AUTOMOTIVE GRADE





ROHS COMPLIANT HALOGEN FREE GREEN

(5-2008)

#### **APPLICATIONS**

- Automotive sensors
- · Ambient light sensors
- Backlight dimming
- Mobil phones
- Notebooks
- Computers

PRODUCT SUMMARY				
COMPONENT	I <sub>ra</sub> (μΑ)	φ (deg)	λ <sub>0.5</sub> (nm)	
TEMD6200FX01	0.04	± 60	430 to 610	

#### Note

· Test condition see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
TEMD6200FX01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805	

#### Note

· MOQ: Minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		$V_R$	16	V
Power dissipation	T <sub>amb</sub> ≤ 55 °C	P <sub>V</sub>	100	mW
Junction temperature		Tj	100	°C
Operating temperature range		T <sub>amb</sub>	-40 to +100	°C
Storage temperature range		T <sub>stg</sub>	-40 to +100	°C
Soldering temperature	In accordance with fig. 6	T <sub>sd</sub>	260	°C
Thermal resistance junction/ambient		R <sub>thJA</sub>	270	K/W

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<b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Breakdown voltage	I <sub>R</sub> = 100 μA, E = 0 lx	V <sub>(BR)</sub>	16			V
Reverse dark current	$V_R = 10 \text{ V}, E = 0 \text{ Ix}$	I <sub>ro</sub>		0.1	5	nA
Diode capacitance	V <sub>R</sub> = 0 V, f = 1 MHz, E = 0 lx	C <sub>D</sub>		60		pF
	V <sub>R</sub> = 5 V, f = 1 MHz, E = 0 lx	C <sub>D</sub>		24		pF
Reverse light current	$E_e$ = 1 mW/cm <sup>2</sup> , $\lambda$ = 550 nm, $V_R$ = 5 V	I <sub>ra</sub>		1		μA
	$E_V = 100 \text{ lx},$ CIE illuminant A	I <sub>ra</sub>	0.03	0.04	0.09	μΑ
Angle of half sensitivity		φ		± 60		deg
Wavelength of peak sensitivity		$\lambda_{p}$		540		nm
Range of spectral bandwidth		λ <sub>0.5</sub>		430 to 610		nm
Rise time	$U_R = 5 \text{ V}, R_L = 50 \Omega, TLMW3300$	t <sub>r</sub>		150		ns
Fall time	$U_R = 5 \text{ V}, R_L = 50 \Omega, TLMW3300$	t <sub>f</sub>		150		ns

## **BASIC CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

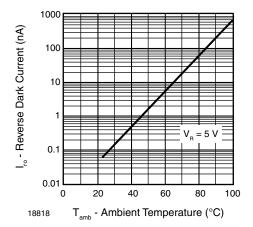


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

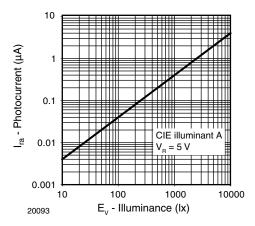


Fig. 2 - Reverse Light Current vs. Illuminance

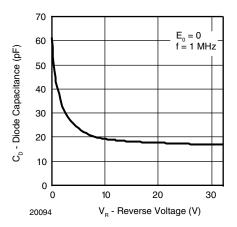


Fig. 3 - Diode Capacitance vs. Reverse Voltage

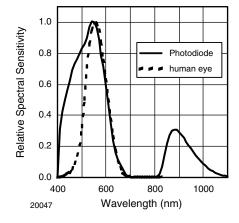


Fig. 4 - Relative Spectral Sensitivity vs. Wavelength



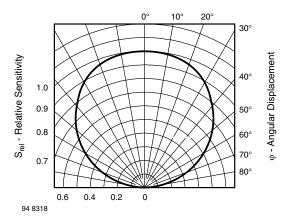


Fig. 5 - Relative Radiant Sensitivity vs. Angular Displacement

#### **SOLDER PROFILE**

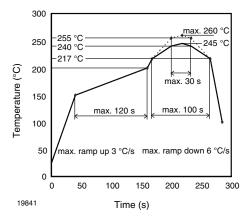


Fig. 6 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

#### **DRYPACK**

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

#### **FLOOR LIFE**

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: Level 3

Floor life: 168 h

Conditions:  $T_{amb}$  < 30 °C, RH < 60 %

### **DRYING**

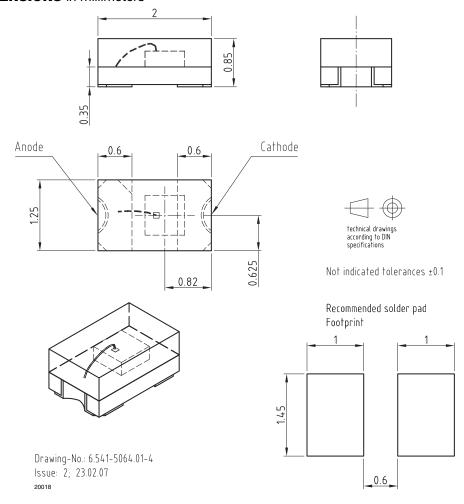
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions:

192 h at 40 °C (+ 5 °C), RH < 5 %

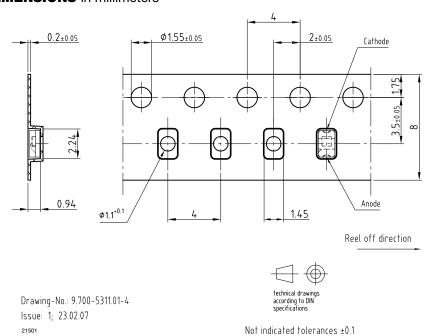
or

96 h at 60 °C (+ 5 °C), RH < 5 %.

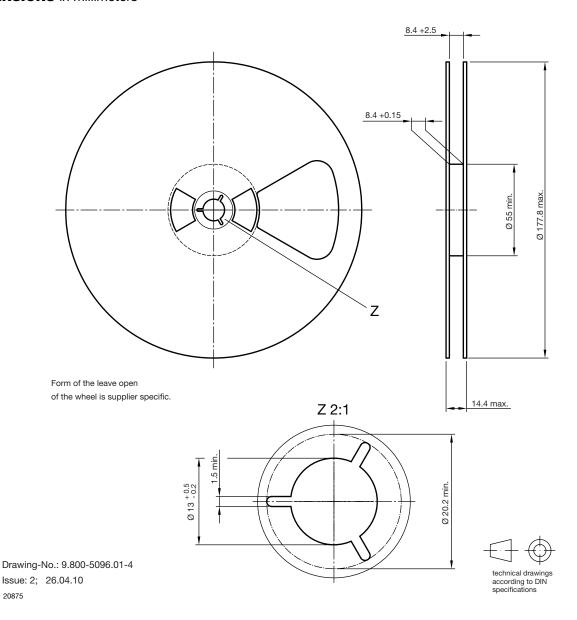
## **PACKAGE DIMENSIONS** in millimeters



## **BLISTER TAPE DIMENSIONS** in millimeters



## **REEL DIMENSIONS** in millimeters





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Vishay

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